

Discontinued

High Performance SAW Filter

- 5 x 5 mm Surface-mount Package
- Complies with Directive 2011/65/EU (RoHS)



Absolute Maximum Ratings

Rating	Value	Units	
Maximum Incident Power in Passband	+10	dBm	
Maximum DC Voltage Between any Two Active Terminals	3	VDC	
Operable Temperature Range	-45 to +125	°C	
Specification Temperature Range	-40 to +85	°C	
Storage Temperature Range in Tape and Reel	-40 to +85	°C	
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s		

515.0 MHz

SF2237C



Electrical Characteristics

Characteristic	Sym	Notes	Min	Тур	Max	Units
Nominal Center Frequency				515.0		MHz
Insertion Loss @ 510 - 520 MHz				2.7	3.0	dB
1 dB Bandwidth	BW ₁		18	34		MHz
Amplitude Ripple, f _C ±11.5 MHz				0.6	1.5	dB _{P-P}
Rejection referenced to IL at Peak:						
400 to 430 MHz			35	50		
430 to 470 MHz			32	40		d D
550 to 600 MHz			20	30		dB
600 to 740 MHz			35	40		
Frequency Temperature Drift				-93		ppm/°C
Case Style	5 x 5 mm Nominal Footprint					
Lid Symbolization, Y=year, WW=week, S=shift, Dot=pin 1 indicator	971, <u>YWWS</u>					
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel					
Reel Size 13 Inch	3000 Pieces/Reel					

Electrical Connections

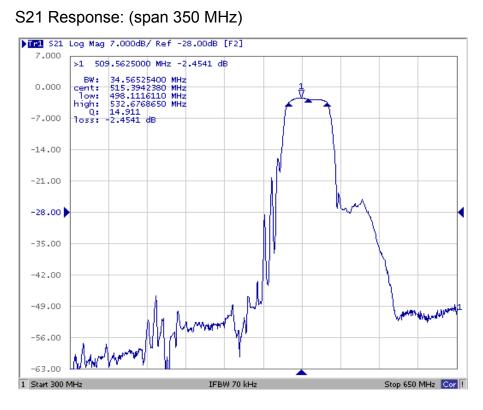
Connection	Terminals
Input	1
Output	5
Case Ground	All others

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

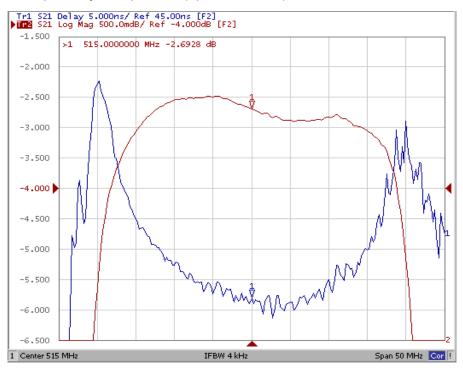
- Unless noted otherwise, all specifications apply over the operating tem-perature range with filter soldered to the specified demonstration board 1. with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- 2 Únless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. Rejection is measured as attenuation below the minimum IL point in the
- 3. passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- 4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 5. The design, manufacturing process, and specifications of this filter are
- Subject to change. Either Port 1 or Port 2 may be used for either input or output in the design. 6. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- 7. US and international patents may apply.
- 8. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

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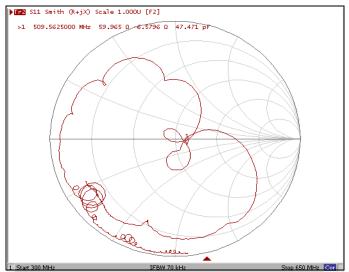
Filter Amplitude and Group Delay Response Plots



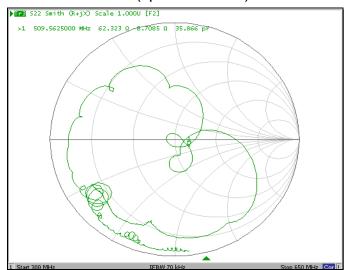
Group Delay Response: (span 50 MHz)



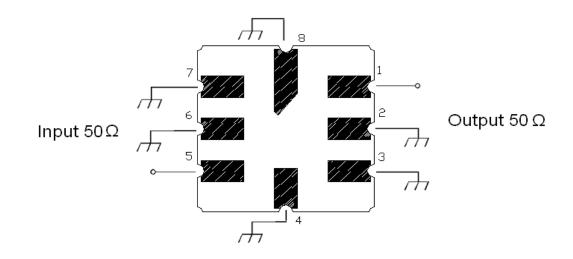
S11 Smith Chart: (span 350 MHz)



S22 Smith Chart: (span 350 MHz)



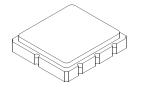
Test Circuit

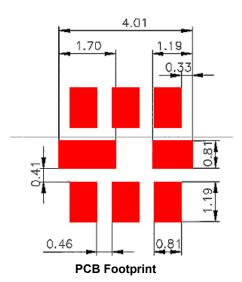


SM5050-8 Case

8-Terminal Ceramic Surface-Mount Case 5.0 X 5.0 mm Nominal Footprint

Case Dimensions





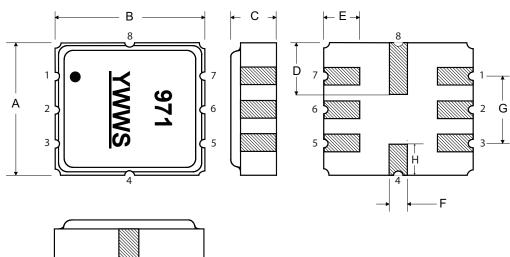
Dimension	mm			Inches			
Dimension	Min	Nom	Max	Min	Nom	Max	
Α	4.80	5.00	5.20	0.189	0.197	0.205	
В	4.80	5.00	5.20	0.189	0.197	0.205	
С	1.30	1.50	1.70	0.050	0.060	0.067	
D	1.98	2.08	2.18	0.078	0.082	0.086	
E	1.07	1.17	1.27	0.042	0.046	0.050	
F	0.50	0.64	0.70	0.020	0.025	0.028	
G	2.39	2.54	2.69	0.094	0.100	0.106	
н		1.35			0.053		

Case Materials

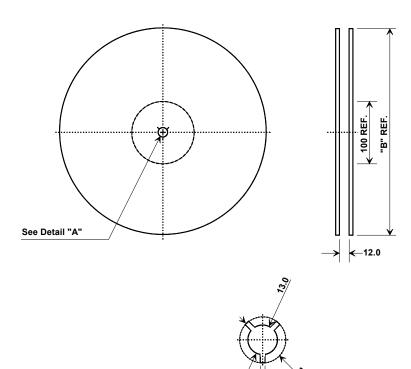
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al ₂ O ₃ Ceramic			
Pb Free				

BOTTOM VIEW

TOP VIEW



Tape and Reel Specifications



2.0

"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions				
Ao	5.3 mm			
Во	5.3 mm			
Ко	2.0 mm			
Pitch	8.0 mm			
W	12.0 mm			

